

Very low offset single bipolar operational amplifier

Features

■ Extremely low offset: 150µV/ max.

■ Low input bias current: 1.8nA

■ LOW V_{io} drift: 0.5µV/°C

■ Ultra stable with time: 2µV/month max.

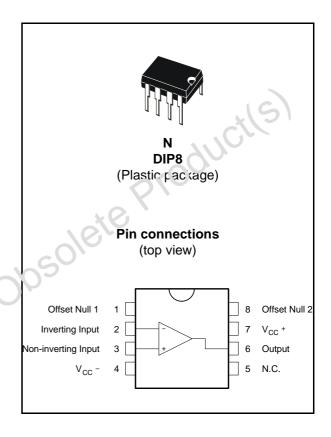
■ Wide supply voltage range: ±3V to ± 22V

■ Temperature range: 0°C to -105°C

Description

The OP07 is a very high precision op-amp with an offset voltage maximum of $150\mu V$.

Offering also low input current (1.8nA) and high gain (400V/mV), the OP07C is particularly suitable for instrumentation applications.



Schematic diagram OP07

1 Schematic diagram

Figure 1. Schematic diagram

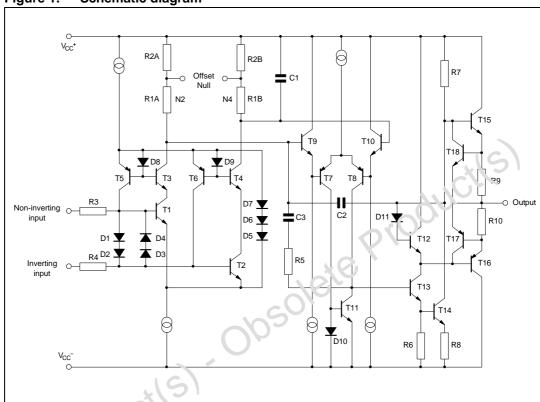
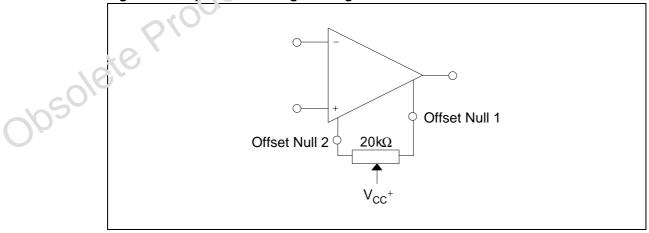


Figure 2. Input of set voltage nulling circuit



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2 Absolute maximum ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	± 22	V
V _{id}	Differential input voltage	± 30	V
V _i	Input voltage	± 22	V
T _{oper}	Operating temperature	-40 to 105	°C
T _{stg}	Storage temperature	-65 to 150	°C
R _{thja}	Thermal resistance junction to ambient ^{(1) (2)} DIP8	85	°C/\V
R _{thjc}	Thermal resistance junction to case ^{(1) (2)} DIP8	4000	°C/W
	HBM: human body model ⁽³⁾	1.5	kV
ESD	MM: machine model ⁽⁴⁾	200	V
	CDM: charged device model ⁽⁵⁾	1.5	kV

- 1. Short-circuits can cause excessive heating and dest uctive dissipation.
- 2. R_{th} are typical values.
- Human body model: 100pF discharged through a 1.5kΩ resistor between two pins of the device, done for all couples of pin combinations with other pins floating.
- Machine model: a 200pF cap is charged to the specified voltage, then discharged directly between two pins
 of the device with no external scars sesistor (internal resistor < 5Ω). Done for all couples of pin
 combinations with other p_n 's .'loaung.
- 5. Charged device mode!: all pins plus package are charged together to the specified voltage and then discharged direct v.ot.e ground.

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Electrical characteristics OP07

3 Electrical characteristics

Table 2. $V_{CC}^+ = 15 \text{ V}, V_{CC}^- = \text{Ground}, T_{amb} = 25^{\circ} \text{ C} \text{ (unless otherwise specified)}$

Symbol	Parameter	Min.	Тур.	Max.	Unit
V_{io}	Input offset voltage $0^{\circ}C \le T_{amb} \le +105^{\circ}C$		60	150 250	μV
	Long term input offset - voltage stability (1)		0.4	2	μV/Mo
DV _{io}	Input offset voltage drift		0.5	1.8	μV/°C
I _{io}	Input offset current ($V_{ic} = 0V$) $0^{\circ}C \le T_{amb} \le +105^{\circ}C$		0.8	6 7	nA
DI _{io}	Input offset current drift		15	5,0	pA/°C
DI _{ib}	Input bias current drift		15	50	pA/°C
R _o	Open loop output resistance		30		Ω
R _{id}	Differential input resistance		33		MW
R _{ic}	Common mode input resistance	3	120		GW
V _{icm}	Input common mode voltage range 0°C ≤ T _{amb} ≤ +105°C	±13 ±13	±13.5		V
CMR	Common-mode rejection ratio (V _{ic} = V _{icm -r, III}) 0°C ≤ T _{amb} ≤ +105°C	100 97	120		dB
SVR	Supply voltage rejection ratio ($V_{CC} = \pm 3$ to $\pm 18V$) $0^{\circ}C \le T_{amb} \le +105^{\circ}C$	90 86	104		dB
A _{vd}	Large signal voltage gain $ \begin{array}{l} V_{CC}=\pm 15,R_L=\frac{1}{2}k\OmegaV_O=\pm 10V\\ 0^{\circ}C\leq T_{amb}\leq \pm 175^{\circ}C\\ V_{CC}=\pm 2, \exists_L=500\OmegaV_O=\pm 0.5V \end{array} $	120 100 100	400 400		V/mV
V _{opp}	Output vc'tage swing $R_L = 10k\Omega$ $R_L = 2k\Omega$ $R_L = 1k\Omega$ $0^{\circ}C \le T_{amb} \le +105^{\circ}C \ R_L = 2k\Omega$	±12 ±11.5	±13 ±12.8 ±12		V
SR	Slew rate ($R_L = 2k\Omega$, $C_L = 100pF$)		0.17		V/µs
GBP	Gain bandwidth product ($R_L = 2k\Omega$, $C_L = 100pF$, $f = 100kHz$)		0.5		MHz
I _{CC}	Supply current - no load $0^{\circ}C \le T_{amb} \le +105^{\circ}C$ $V_{CC} = \pm 3V$		2.7 0.67	5 6 1.3	mA

OP07 Package information

 $V_{CC}^+ = 15 \text{ V}, \ V_{CC}^- = \text{Ground}, \ T_{amb} = 25^{\circ} \text{ C} \text{ (unless otherwise specified) (continued)}$ Table 2.

Symbol	Parameter	Min.	Тур.	Max.	Unit
e _n	Equivalent input noise voltage f = 10Hz f = 100Hz f = 1kHz		11 10.5 10	20 13.5 11.5	<u>nV</u> √Hz
i _n	Equivalent input noise current f = 10Hz f = 100Hz f = 1kHz		0.3 0.2 0.1	0.9 0.3 0.2	<u>pA</u> √Hz

^{1.} Long term input offset voltage stability refers to the average trend line of Vio vs time over extended periods after the first 30 roducils days of operation.

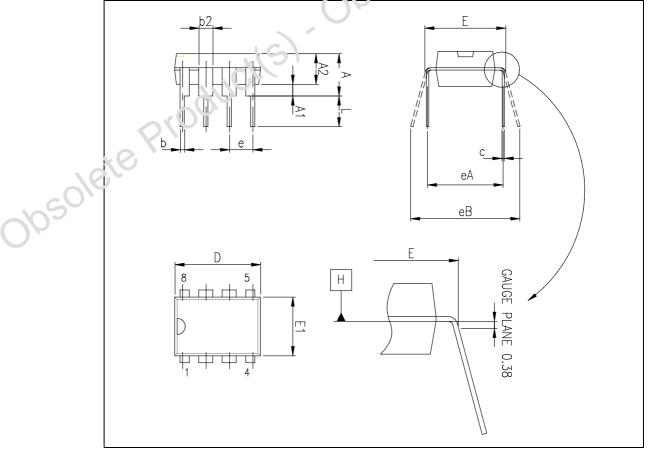
Package information 4

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Package information OP07

Figure 3. DIP8 package mechanical data

			Dime	ensions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α			5.33			0.210
A1	0.38			0.015		
A2	2.92	3.30	4.95	0.115	0.130	0.195
b	0.36	0.46	0.56	0.014	0.018	0.022
b2	1.14	1.52	1.78	0.045	0.060	0.070
С	0.20	0.25	0.36	0.008	0.010	0.014
D	9.02	9.27	10.16	0.355	0.365	0.400
E	7.62	7.87	8.26	0.300	(.510	0.325
E1	6.10	6.35	7.11	0.240	0.250	0.280
е		2.54		No. 1	0.100	
eA		7.62		2/6	0.300	
eB			10.92			0.430
L	2.92	3.30	3.81	0.115	0.130	0.150



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OP07 Ordering information

Ordering information 5

Table 3. **Order codes**

Part number	Temperature range	Package	Packing	Marking
OP07C OP07CN	0°C, +105°C	DIP8	Tube	OP07CN

Revision history 6

Document revision history Table 4.

Table 4. Do	Revision	vision history Changes
20-May-2003	1	Initial release.
23-Jul-2007	2	Format update. R _{thja} , R _{thjc} , and ESD values added in <i>Table 1: Absolute maximum ratings</i> .
		Temperature and modified to 0-105°C.
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ate Pro	ducti	0,

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